

DIX4192EVM-PDK User's Guide

This user's guide provides a reference document for the DIX4192EVM-PDK product development kit. The kit includes a DIX4192EVM daughterboard as well as a DAIMB motherboard. Together, the daughter and mother boards form a modular platform for evaluating the function and performance of the Texas Instruments' DIX4192 integrated circuit. Applications software is provided with the PDK for writing and reading registers and data buffers integral to the DIX4192 device. The software communicates with the device under test using the USB slave interface on the DAIMB board. The software requires a host PC running the Microsoft Windows™ 2000 or XP operating system.

Throughout this document, the acronym *EVM* and the phrase *evaluation module* are synonymous with the DIX4192EVM. The acronym *PDK* refers to the daughterboard EVM and DAIMB motherboard combination. This document includes information regarding absolute operating conditions, hardware configuration, and software installation and operation. Complete electrical schematics and a bill of materials for both the EVM and the DAIMB boards are also included.

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1 Introduction

The DIX4192EVM-PDK provides a modular solution for evaluating the function and performance of the DIX4192 device from Texas Instruments. The PDK includes a motherboard (the DAIMB) and a daughterboard (the EVM). [Figure 1](#) depicts the modular platform concept, with the EVM plugged into the DAIMB board. Connectors are indicated and labeled for ease of identification.

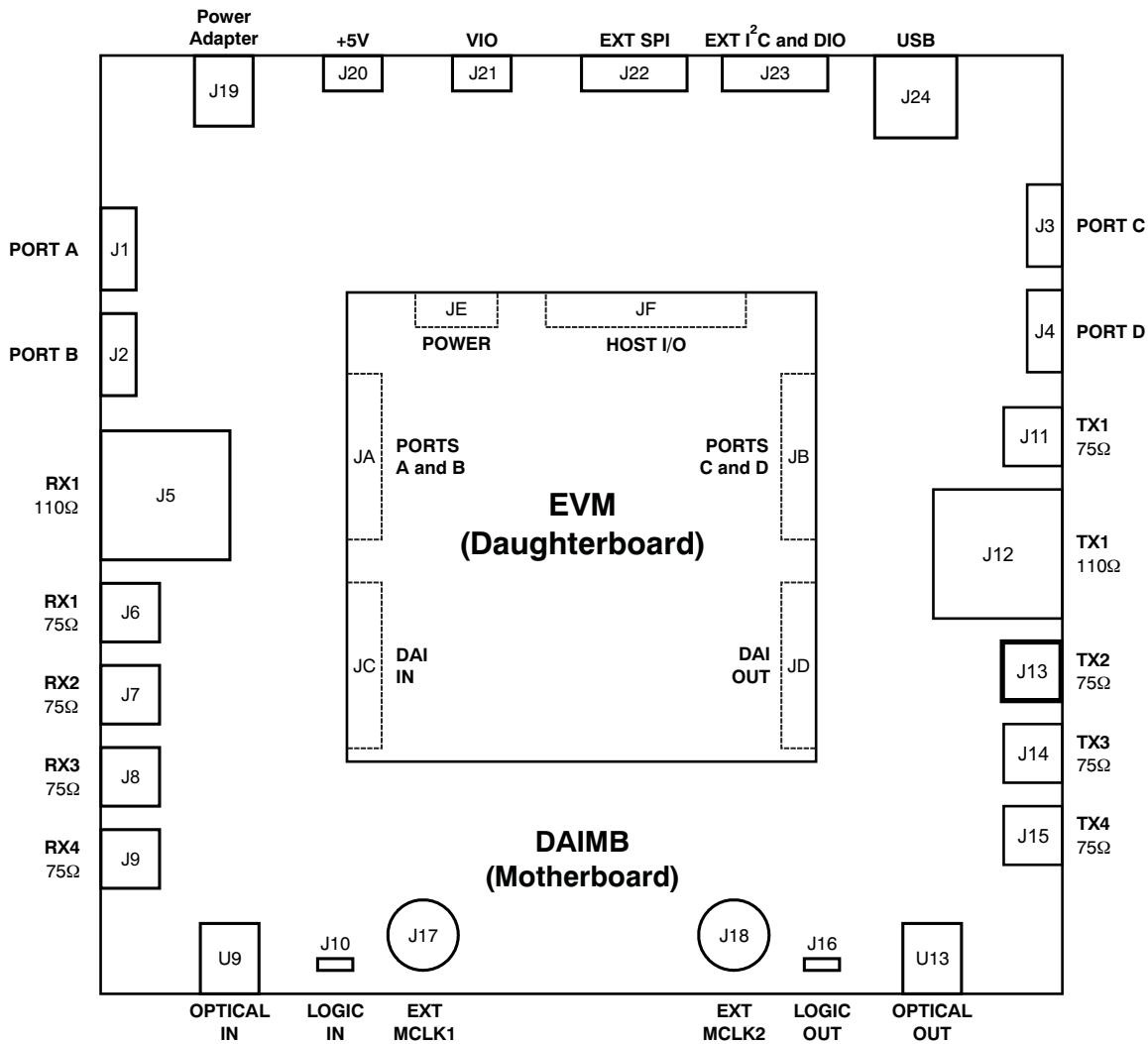


Figure 1. Illustration of the PDK Platform Utilizing a DAIMB Motherboard and a Daughterboard EVM

The modular design allows for common functions to be integrated onto the DAIMB motherboard, while device-specific functions are integrated onto the daughterboard EVM. The modular platform supports a variety of digital audio interface devices by simply replacing the daughterboard EVM shipped with the product-specific PDK. Texas Instruments products supported by this modular platform include digital audio interface receivers, transmitters, transceivers, and combination SRC/transceiver products.

The primary features of the DIX4192EVM-PDK include:

- A USB slave interface, implemented with a Texas Instruments [TAS1020B USB controller](#), and supported by computers running Microsoft Windows 2000 or XP. The USB interface supports bus or self-powered operation, and communicates with the EVM daughterboard via an SPI™ or I²C™ interface.
- Buffered headers support up to four audio serial port interfaces, compatible with I²S™-style or time-division multiplexed (TDM) data formats. Only two of these ports are utilized for the DIX4192EVM.
- Six digital audio input ports support AES3-balanced inputs, S/PDIF coaxial and optical sources, and CMOS logic level inputs.
- Six digital audio output ports support AES3-balanced, S/PDIF coaxial and optical, and CMOS logic level outputs. Three of the ports are utilized for the DIX4192EVM.
- Flexible reference and master clock generation are supported, using either onboard oscillators or external clock sources.
- Power may be provided from a wall adapter (included), or an external +5V regulated power supply. An optional external logic I/O (or VIO) supply connection is also supported.
- Onboard linear regulators derive +1.8V, +3.3V, and +5V power supplies from the supplied power adapter, external supplies, and/or the USB bus connection.
- An LED indicator is provided for the DIR Lock output flag.
- Applications software provides functions for writing and reading the on-chip registers and data buffers. The applications software is compatible with personal computers with at least one USB 1.x or 2.0 port and running the Microsoft Windows 2000 or XP operating systems.

2 Quick Start

This section provides information regarding handling, package contents, and the absolute operating conditions for the DIX4192EVM-PDK.

2.1 *Electrostatic Discharge Warning*

WARNING

Failure to observe proper ESD handling precautions may result in damage to EVM components.

Many of the components used in the assembly of the PDK are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling procedure when unpacking and handling the PDK components. All handling should be performed at an approved ESD workstation or test bench, using a grounded wrist strap. Failure to observe proper handling procedure may result in damage to EVM components.

2.2 Product Development Kit (PDK) Package Contents

The DIX4192EVM is included as part of a complete evaluation module package, referred to as a Product Development Kit (PDK). Each PDK package includes:

- One DIX4192EVM board.
- One DAIMB board.
- One printed copy of this DIX4192EVM-PDK User's Guide.
- One printed copy of the [DIX4192](#) datasheet.
- One power supply for powering the PDK.
- One USB cable (Type A to Type B male plugs).
- One CD-ROM containing the EVM applications software, support files, and documentation.

2.3 Absolute Operating Conditions

CAUTION

Exceeding the absolute operating conditions may result in improper EVM operation or damage to the evaluation module and/or the equipment connected to it.

The user should be aware of the absolute operating conditions for the PDK. [Table 1](#) summarizes these conditions.

Table 1. Absolute Operating Conditions

	Min	Max	Units
Power Supplies			
Power Adapter (J19)	+6.0	+10.0	VDC
EXT +5V (J20)	-0.3	+5.5	VDC
EXT VIO	-0.3	+3.6	VDC
Digital Input Voltage Range			
Daughterboard Connectors (JA-JD,JF)	-0.3	+3.6	V
PORT A through PORT D (J1-J4)	-0.3	+3.6	V
EXT SPI and EXT I ² C & DIO (J22 and J23)	-0.3	+3.6	V
RX1 Balanced Input (J5), measured differentially	—	7.2	V _{PP}
RX1 Unbalanced Input (J6)	—	3.6	V _{PP}
RX2 through RX4 (J7-J9)	—	3.6	V _{PP}
EXT MCLK1 and EXT MCLK2 (J17 and J18)	-0.3	+3.6	V
LOGIC INPUT (J10)	-0.3	+5.5	V
PDK Operating Temperature	0	+70	°C

2.4 Jumper Configuration

This subsection provides an overview of the required jumper configuration for both the DAIMB motherboard and EVM daughterboard. Refer to the electrical schematics included in [Section 4](#) of this document for connection details, as well as jumper functions that may not be discussed in this section.

2.4.1 Power-Supply Jumpers

Power-supply configuration for the PDK is enabled using jumpers JMP1 through JMP3, located on the DAIMB motherboard. Figure 2 illustrates the options for each of these jumpers.

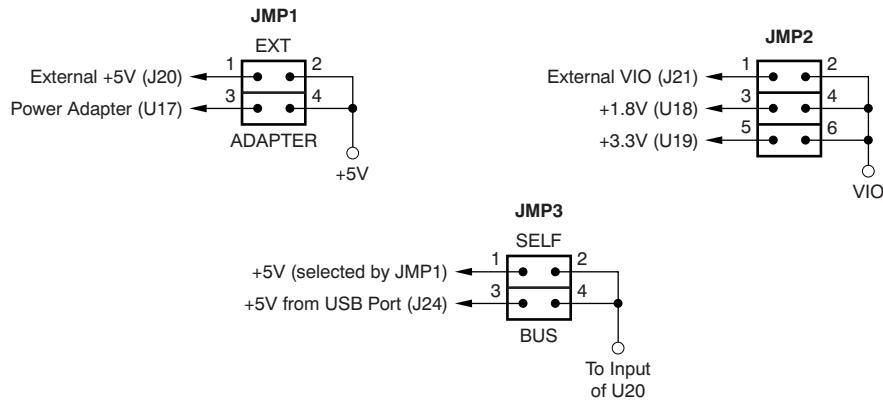


Figure 2. Power-Supply Jumper Configuration (DAIMB Motherboard)

By default, jumper JMP1 is configured for Power Adapter input at J19, jumper JMP2 is set up for a +3.3V logic I/O (or VIO) supply, and jumper JMP3 is set up for Bus power operation (+5V from connector J24). The +3.3V logic I/O supply is required in this case to maintain logic level compatibility with the USB slave interface circuitry.

Jumpers JMP5 through JMP8 on the EVM daughterboard are provided for measuring power-supply current. By default, these jumpers are shorted with bus wire, soldered during assembly of the board.

2.4.2 SPI and I²C Jumpers

Jumpers JMP2 through JMP4, located on the EVM daughterboard, are utilized to select SPI or I²C host interface connections for the DIX4192EVM. Refer to Table 2 through Table 4 for jumper configuration.

Table 2. Jumper JMP2 Configuration (EVM Daughterboard)

JMP2 Pins 1–2	JMP2 Pins 3–4	Host Interface Selection
OPEN	SHORT	SPI
SHORT	OPEN	I ² C

Table 3. Jumper JMP3 Configuration (EVM Daughterboard)

JMP3 Pins 1–2	JMP3 Pins 3–4	Host Interface Selection
OPEN	SHORT	SPI
SHORT	OPEN	I ² C

Table 4. Jumper JMP4 Configuration (EVM Daughterboard)

JMP4 Pins 1-2	JMP4 Pins 3-4	Host Interface Selection
OPEN	OPEN	SPI
SHORT	SHORT	I ² C

2.4.3 RX4 Receiver Input Jumper

Jumper JMP1, located on the EVM daughterboard, is used to select the input source for the RX4 line receiver inputs. Selection options are shown in [Table 5](#).

Table 5. Jumper JMP1, RX4 Input Selection (EVM Daughterboard)

JMP1 Pins 1-2	JMP1 Pins 3-4	JMP1 Pins 5-6	JMP1 Pins 7-8	RX4 Input Source
SHORT	SHORT	OPEN	OPEN	RX4 Unbalanced 75Ω Input (DAIMB connector J9)
OPEN	SHORT	SHORT	OPEN	Optical Input Receiver (DAIMB U9)
OPEN	SHORT	OPEN	SHORT	Logic Level Input (DAIMB header J10)

2.5 Switch Configuration

This subsection provides an overview of the DIP switch configuration for both the DAIMB motherboard and EVM daughterboard.

2.5.1 Audio Serial Port Slave/Master Configuration

The audio serial ports for the DIX4192 may operate in either Slave or Master mode. Switches SW1 and SW2 must be configured to match the programmed register configurations for the Port A and Port B audio serial ports on the DIX4192.

Port A of the DIX4192 is connected to Port D (or header J4) on the DAIMB motherboard, while Port B is connected to Port B (or header J2) on the motherboard. Switch SW1 must be set to match the Port B slave/master configuration, while switch SW2 must be set to match the Port A slave/master configuration. Switch configuration is summarized in [Table 6](#), where $x = B$ for Port B, and $x = D$ for Port A.

Table 6. Audio Serial Port Slave/Master Switch Configuration (DAIMB Motherboard)

Switch SW1 or SW2, x_S/M	Port Configuration
LO	Master
HI	Slave

2.5.2 USB Serial Peripheral Interface (SPI) Port Configuration

CAUTION

When the I²C bus is utilized for host communications, the $\overline{\text{USBSP1}}$ switch must be set to HI.

For the DAIMB motherboard, the $\overline{\text{USBSP1}}$ switch on SW5 is utilized to enable or disable the tri-state buffers for the USB controller SPI port connections. [Table 7](#) summarizes the $\overline{\text{USBSP1}}$ switch settings.

Table 7. USB SPI Port Configuration (DAIMB Motherboard)

Switch SW5, $\overline{\text{USBSP1}}$	USB-Based SPI Interface
LO	Enabled; the SPI port may be utilized for DIX4192 host communications.
HI	Disabled; the SPI port outputs are set to a high-impedance state.

When the USB controller SPI interface is disabled, an external SPI host may be connected via header J22. Refer to the DAIMB electrical schematics in [Section 4](#) of this document for the header pin configuration.

2.5.3 MCLK1 and MCLK2 Clock Configuration

The DAIMB board supports both onboard and external clock generation for two clocks, referred to as *MCLK1* and *MCLK2*. The MCLK1 clock source is buffered and routed to the RXCKI input (pin 13) of the DIX4192 on the EVM daughterboard. The MCLK2 source is buffered and routed to the MCLK input (pin 25) of the DIX4192 on the EVM daughterboard.

Switch SW3 selects the clock source for the MCLK1 (that is, RXCKI) clock, while SW4 selects the clock source for MCLK2 (that is, MCLK). [Table 8](#) and [Table 9](#) summarize the SW3 and SW4 switch settings.

Table 8. MCLK1 Clock Source Selection (DAIMB Daughterboard)

Switch SW3, OSC2	Switch SW3, OSC1	MCLK1 (or RXCKI) Source Selection
LO	LO	External clock source at BNC connector J17 (X1 and X2 are disabled)
LO	HI	Oscillator X1, 24.576MHz \pm 50ppm
HI	LO	Oscillator X2, 22.5792MHz \pm 50ppm
HI	HI	Not allowed due to Oscillator X1 and X2 output contention.

Table 9. MCLK2 Clock Source Selection (DAIMB Daughterboard)

Switch SW4, OSC4	Switch SW4, OSC3	MCLK2 (or MCLK) Source Selection
LO	LO	External clock source at BNC connector J18 (X3 and X4 are disabled)
LO	HI	Oscillator X3, 24.576MHz \pm 50ppm
HI	LO	Oscillator X4, 22.5792MHz \pm 50ppm
HI	HI	Not allowed due to Oscillator X3 and X4 output contention.

2.5.4 Host Interface Configuration

For the EVM daughterboard, DIP switch SW1 is utilized to manually select the DIX4192 control port mode via the CPM input (pin 18). Bits A0 and A1 for the DIX4192 I²C slave address may also be configured using this switch. [Table 10](#) and [Table 11](#) summarize the operation of the SW1 switches.

Table 10. DIX4192 Control Port Mode Configuration (EVM Daughterboard)

Switch SW1, CPM	SPI or I ² C
LO	SPI
HI	I ² C

Table 11. I²C 7-Bit Slave Address Configuration (EVM Daughterboard)

Switch SW1, A1	Switch SW1, A0	7-Bit Slave Address (Binary)	Slave Address for Command Files (Hex)
LO	LO	1110000	E0
LO	HI	1110001	E2
HI	LO	1110010	E4
HI	HI	1110011	E6

2.6 Audio, Power, and Logic I/O Connections

Figure 3 illustrates the power, USB, and primary audio input/output connections for the PDK. Headers J2 and J4 provide access to the DIX4192 audio serial ports, Port A (J4) and Port B (J2), as well as the DIR recovered clock output, RXCKO (pin 12). The pin assignments for the headers are also shown in Figure 3. Connectors J5 through J9, as well as optical receiver U9, provide the inputs for AES3 and S/PDIF digital audio sources. Connectors J11 and J12, along with optical transmitter U13, provide the AES3-encoded digital outputs for connection to external audio systems and test equipment. The J17 and J18 BNC connectors allow connection to external clock sources when the onboard oscillators are disabled. General-purpose outputs, as well as the DIT block start (BLS) and DIT internal frame synchronization (SYNC) clocks, are made available at header J23. The power adapter provided with the PDK is connected to the DAIMB motherboard at power jack J19. The host PC is connected to the PDK via the supplied USB cable, with connector J24 providing access to the DAIMB motherboard USB slave interface.

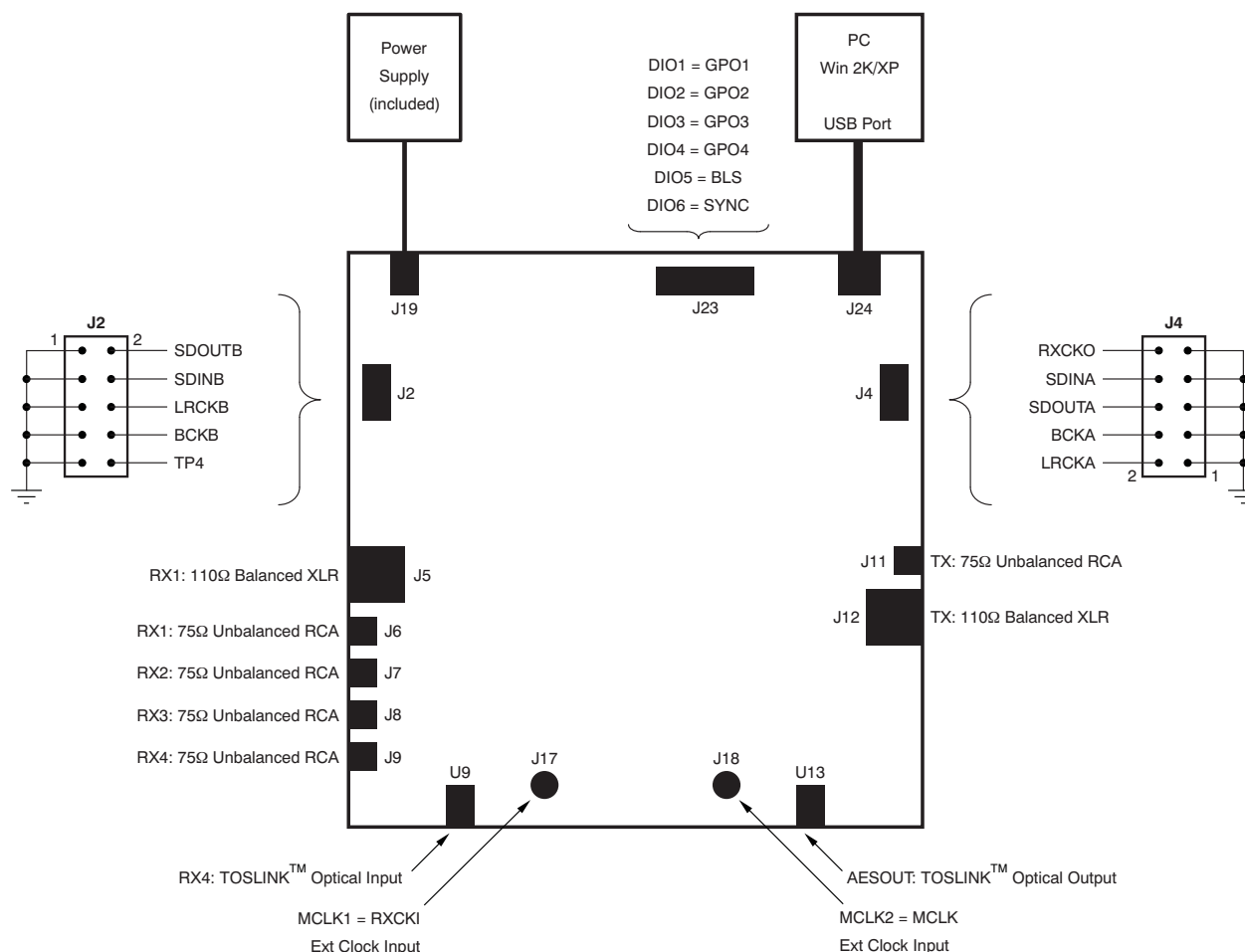


Figure 3. PDK Power, Host, and Input/Output Connections

3 Software Overview, Installation, and Operation

This section provides a discussion of the applications software that accompanies the PDK, including system requirements, installation procedures, and software operating instructions.

3.1 Overview

The applications software provided with the PDK allows the user to program and read the contents of DIX4192 control and status registers, as well as the channel status and user data buffers for both the DIR and DIT. The software is referred to as the *USB Serial Commander*, and is a product of Texas Instruments (portions of the software are copyright by National Instruments). Refer to the End Users License Agreement included with the software.

3.2 System Requirements

The applications software functions on computers that run the Microsoft Windows 2000 or XP operating systems, and include at least one available USB 1.x or USB 2.0 port. A CD-ROM drive is also required for software installation. A minimum of 256MB of system RAM is required, while 512MB of system RAM is recommended. Installation of the applications software requires a minimum of 50MB of free hard disk space.

3.3 Installation Procedure

The following steps are required to install the USB Serial Commander Software. It is assumed that the user is familiar with the Windows 2000 or XP operating system, including window and menu navigation.

Step 1: Insert the accompanying CD-ROM into the PC CD-ROM drive.

Step 2: Go to the folder named *usc_installer* on the CD-ROM. Open the folder and double-click on the file named *setup.exe*. Follow the instructions and prompts given by the installer program.

Step 3: When the main installation is complete, a dialog box will come up informing you about installing NI-VISA™ 3.1 Runtime. This file is a self-extracting archive. Click *OK* to proceed. You will then be presented with a WinZip™ dialog. Simply click *Unzip*; the archive self-extracts and automatically runs the NI-VISA 3.1 Runtime installer.

Step 4: Follow the instructions in the NI-VISA 3.1 Runtime Installer. When prompted for which features to install, do the following:

1. Click on the disk icon next to NI-VISA 3.1.
2. Select, **Do not install this feature.**
3. Click on the disk icon next to USB.
4. Select the option that installs this feature.
5. Click *Next*.

Step 5: Accept the license agreement, and continue the installation.

Step 6: When this completes, click *Finish* on the USB Serial Commander installer window.

Step 7: Restart your computer.

Step 8: When your computer is restarted, connect the DIX4192EVM-PDK to the host PC using the supplied a USB cable. Windows should recognize the new device as *USB-MODEVM*. However, on some systems, it will be recognized as a USB Human Interface Device rather than an NI-VISA USB device.

To check this configuration, go to *Start*→*Control Panel*→*System*→*Hardware*→*Device Manager*. Look in the list and verify whether any NI-VISA USB Devices are shown. If so, the USB-MODEVM should be included in the list of the NI-VISA USB devices, and you can proceed to Step 10.

If the USB-MODEVM appears instead under *Human Interface Devices*, right-click on the device and select *Update Driver...* In the driver update screen, choose the option to select the driver from a list. When the list is given, you should have the choice of either a Human Interface Device or the USB-MODEVM. Select the *USB-MODEVM* and install the new driver.

If the USB-MODEVM does not appear as an option, go to the **C:\Windows\inf** directory and see if the *USB-MODEVM_WDM.inf* file exists. If this file is present, right-click on the file and select *Install...* Repeat the *Update Driver...* process described in the previous paragraph.

If the *USB-MODEVM_WDM.inf* file does not exist in the **C:\Windows\inf** directory, go to the CD-ROM and locate the **inf_file.zip** archive. This archive contains the *USB-MODEVM_WDM.inf* file. Copy the archive to your hard disk, unzip the archive, and move the *USB-MODEVM_WDM.inf* file to the **C:\Windows\inf** directory. Once the file is moved, right-click on the file and select *Install...* Repeat the *Update Driver...* process described previously in this section.

Step 9: Disconnect the USB_MODEVM hardware and reconnect to the USB cable. Repeat Step 8 to check that it is now recognized as an NI-VISA USB Device. When the hardware is recognized and listed as a NI-VISA USB device, proceed to Step 10.

Step 10: Installation is complete. You may now proceed with using the PDK software.

3.4 Operating the Applications Software

To start the applications software, click on the *Start* menu icon and navigate to *Programs*→*Texas Instruments*→*USB-SerialCommander*. Click on the *USB-SerialCommander* to start the application. The window shown in [Figure 4](#) appears. The Command Buffer text area will be empty when the application initially launches.

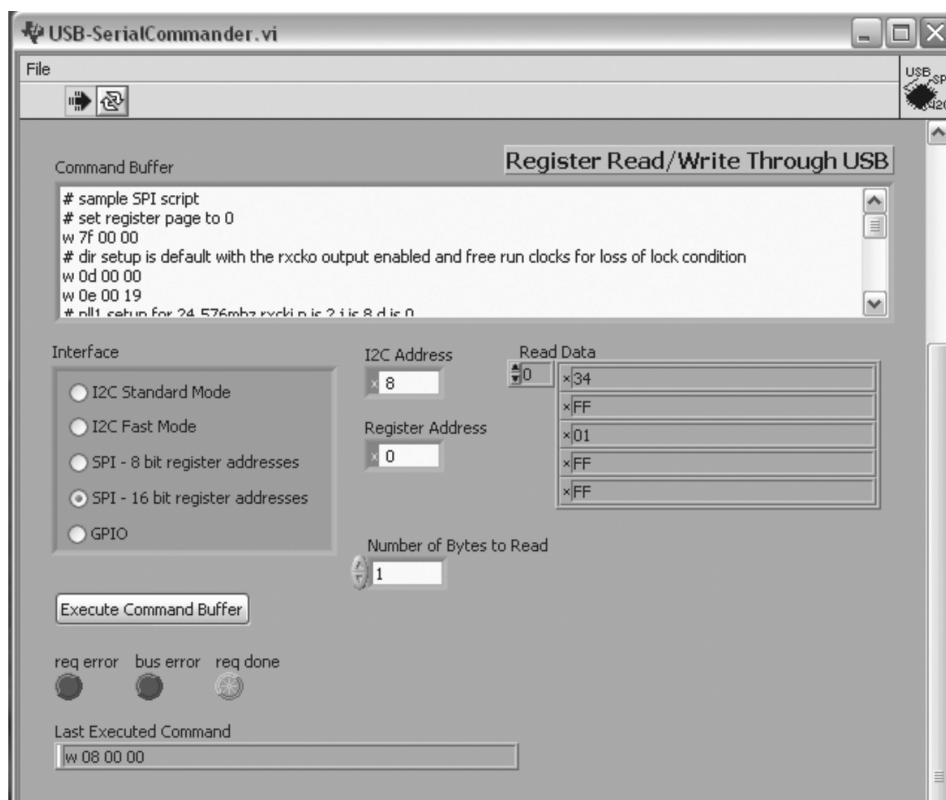


Figure 4. Applications Software Window (USB Serial Commander)

The first order of business is to select the Interface, using one of the five radio buttons shown in the Interface panel. For an I²C host interface configurations, either the *I²C Standard Mode* or *I²C Fast Mode* may be selected. For an SPI host interface configuration, the *SPI-16 bit register addresses* mode must be selected.

On the CD-ROM accompanying the PDK, there is a folder named *Sample Command Files*. These files have been written to exercise specific portions and functions of the DIX4192. The sample files also provide the user with code that can be copied and modified as needed, assisting the learning process. Any standard text editor, such as Notepad, can be utilized to edit and create command files.

Click on the applications **File** menu. There is only one selection under the File menu: *Open Command File...* Clicking on this menu selection displays an open file dialog, where sample command files may be located and loaded.

Once a command file has been loaded, the Command Buffer text area displays the script code. You may scroll through this code, as well as select and edit code as needed. The user can also select and delete the contents of the Command Buffer and manually enter his or her own script code. [Section 3.5](#) and [Section 3.6](#) of this guide provide command syntax information for writing scripts. When you are ready to execute the script code in the Command Buffer, simply click on the *Execute Command Buffer* button.

3.4.1 Error Indicators

There are three indicators below the *Execute Command Buffer* button. When a command buffer is successfully executed, the **req done** indicator glows green. If a command request or an SPI/I²C bus error occurs, then the **req error** or **bus error** indicators glow red. Typical errors include selecting the wrong interface mode for the given command buffer contents, running command syntax that is invalid, and bus configuration or electrical errors.

3.4.2 Last Executed Command Field

This field is located below the error indicators, and contains the text of the last executed command (not including Break commands).

3.4.3 Read Data Display

The Read Data display shows a list of hexadecimal values, with the first four values being program status information, followed by the data bytes read from control or status registers using a Read command. [Figure 5](#) illustrates the results of an SPI read command. The Last Executed Command field shows that a read command was executed. This information is reiterated in the text field to the left of the Read Data display. Ignoring the first four bytes of the Read Data display, the last four bytes correspond to the data located in the four register addresses referenced by the Read command.

3.4.4 Command Script Paused Dialog

This dialog is presented when a Break command is executed in the Command Buffer, and is shown in [Figure 5](#). The Break command pauses the Command Buffer execution until the **OK** button is clicked. Read commands must always be followed by a Break command, so that the user may evaluate the Read Data display results.

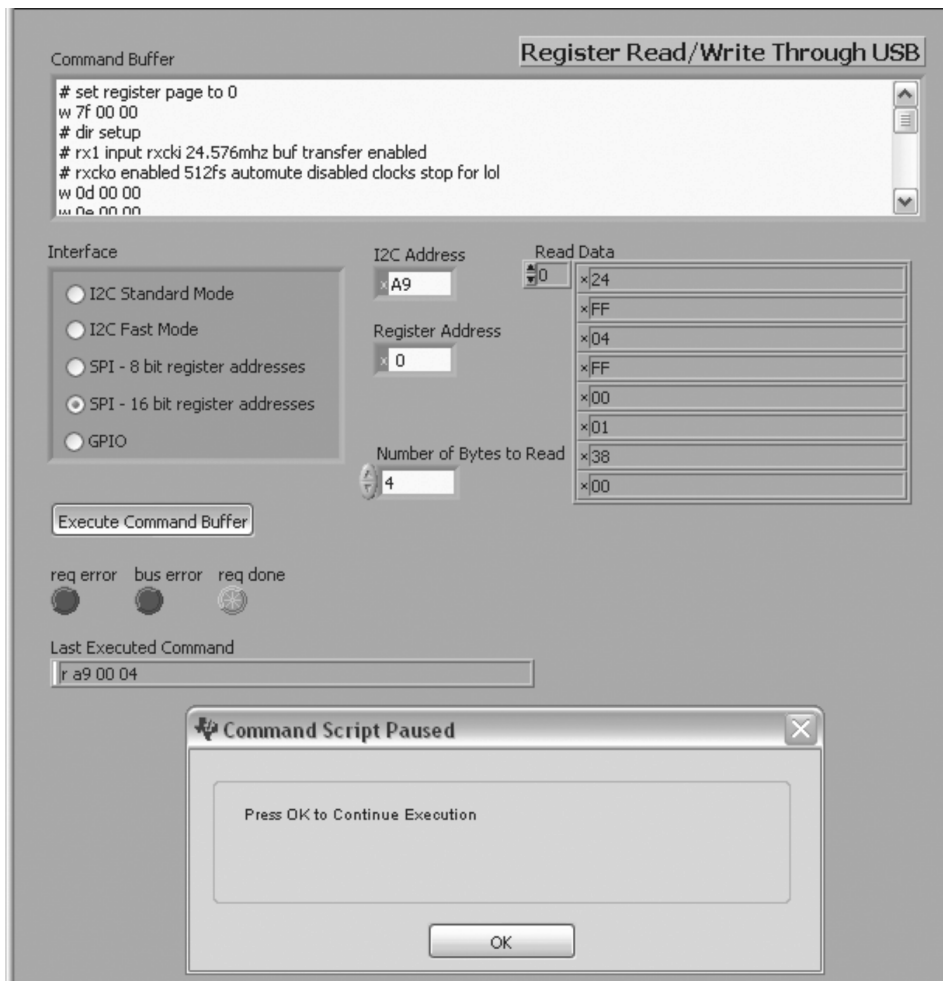


Figure 5. Example of a Readback Display and Break Message in the USB Serial Commander Application

3.5 Command Syntax for SPI Communications

Simple but strict command syntax is required for the command files utilized by the applications software. The command syntax for SPI communications are summarized in [Table 12](#). Each command must be terminated with a carriage return, and must fit on a single line.

Table 12. SPI Command Syntax

Command	Syntax
Write	w rr 00 dd
Read	r rr 00 bb
Break	b
Comment	# write your comments here
Interface Mode	i spi16

Where:

- rr = The register address (Hex)
- dd = The register data (Hex)
- bb = The number of bytes to be read (Hex)

For the DIX4192, the SPI 16-bit address mode must always be utilized, as the second byte (00) is interpreted as the second byte of the address by the USB Serial Commander. The first line of the command file should always be the interface mode syntax shown in [Table 12](#).

When setting the register address for an SPI command, the most significant bit of the address is the Read/Write bit. Set this bit to '0' for Write operations, and to '1' for Read operations.

Example 1.

```
# write register 01 to power-up all function blocks
w 01 00 3f
```

Example 2.

```
# read the Q sub code data registers and then break for read data display results
r 9f 00 0a
b
```

3.6 Command Syntax for I²C Communications

The command syntax for I²C communications are summarized in [Table 13](#). Each command must be terminated with a carriage return, and must fit on a single line.

Table 13. I²C Command Syntax

Command	Syntax
Write	w ss rr dd
Read	r ss rr bb
Break	b
Comment	# write your comments here
Interface Mode (I ² C Slow)	i i2cslow
Interface Mode (I ² C Fast)	i i2cfast

Where:

- ss = The I²C slave address for the DIX4192 (Hex).
- rr = The register address byte (Hex)
- dd = The register data (Hex)
- bb = The number of bytes to be read (Hex)

For the DIX4192, the I²C interface mode may be Slow or Fast. The first line of the command file should always indicate the speed of the interface, and match the selection shown in the Interface section of the USB Serial Commander window. Generally, the interface may be set to Fast mode for all operations.

When setting the slave address, the R/W bit does not need to be included, because the Write or Read command will set this bit automatically.

The most significant bit of the Register Address Byte is the INC, or auto-increment bit. When set to '0', auto-increment mode is disabled. When set to '1', auto-increment mode is enabled. Refer to the datasheet for additional information regarding auto-increment mode for I²C write and read operations.

Example 3.

```
# write register 01 to power up all function blocks  
w e0 01 3f
```

Example 4.

```
# read the non pcm status register and then break for read data display results  
r e0 12 01  
b
```

Example 5.

```
# read the Q sub code data registers and then break for read data display results  
# reading multiple registers requires that the auto increment bit be set to 1  
r e0 9f 0a  
b
```

4 Hardware Reference

This section includes schematics for the EVM and DAIMB boards, as well as a Bill of Materials for each board.

4.1 Schematics

The schematics for the EVM and DAIMB boards are shown in [Figure 6](#) through [Figure 8](#).

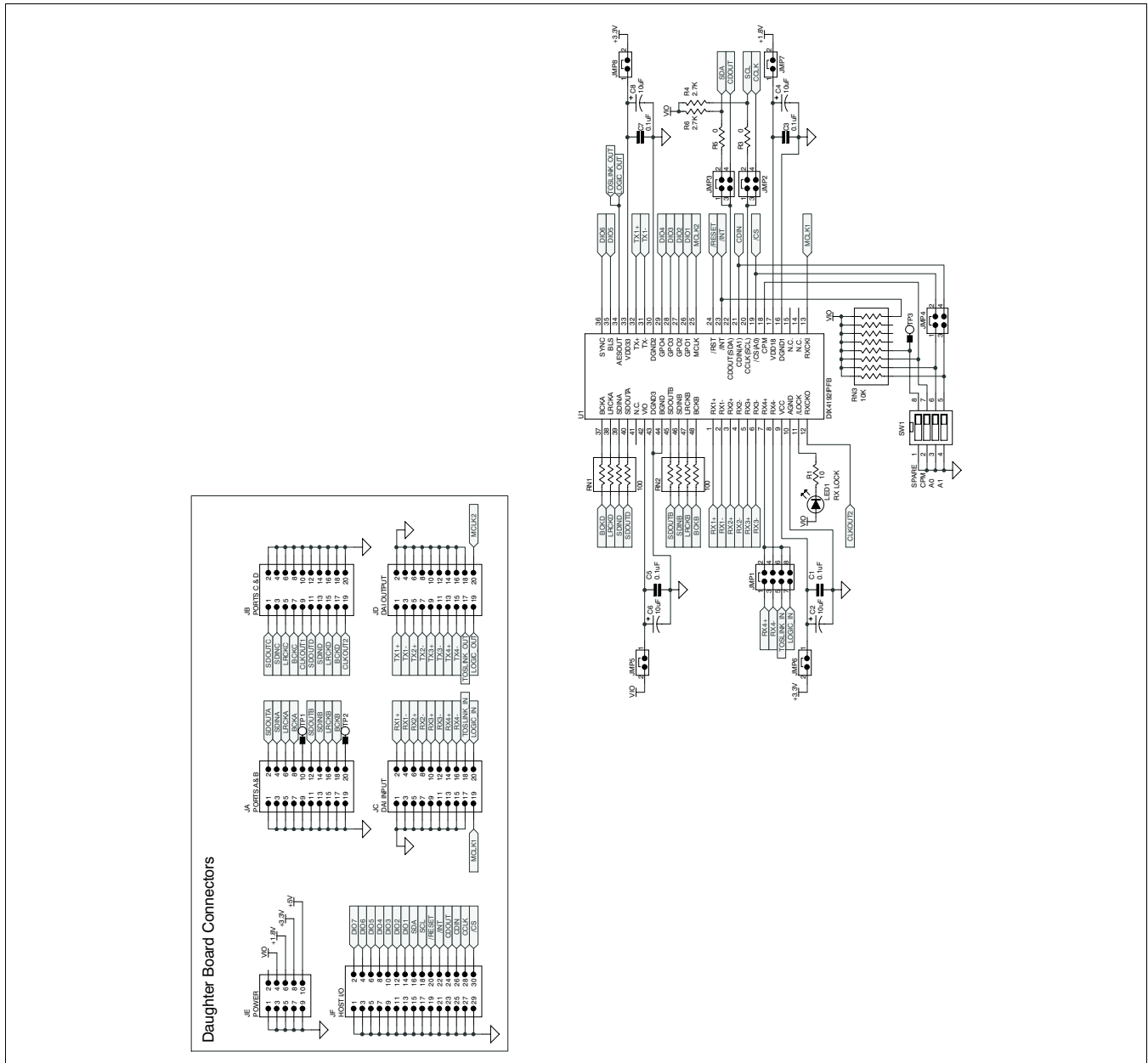


Figure 6. Electrical Schematic: DIX4192EVM Daughterboard

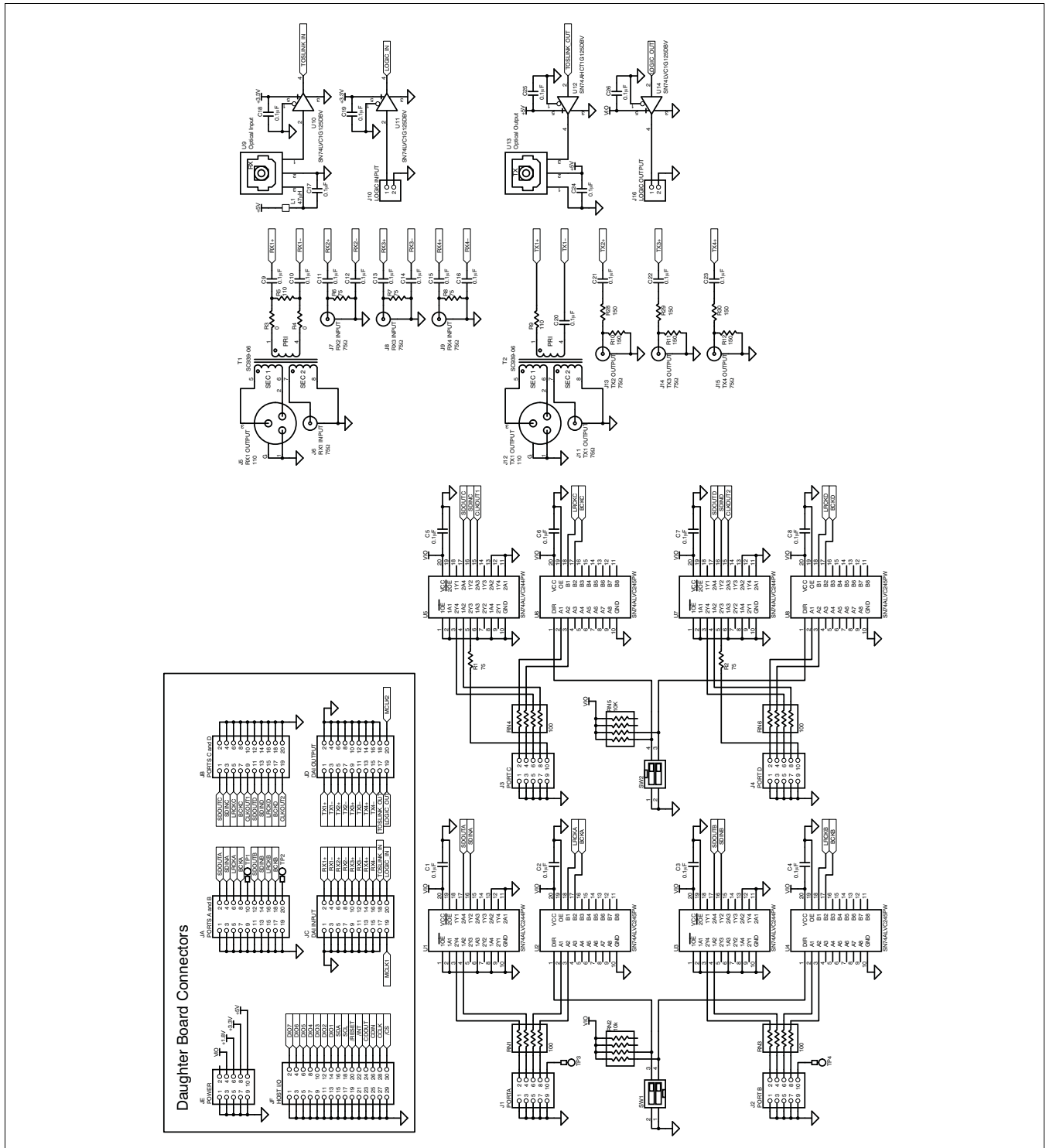


Figure 7. Electrical Schematic: DAIMB Motherboard, Page 1

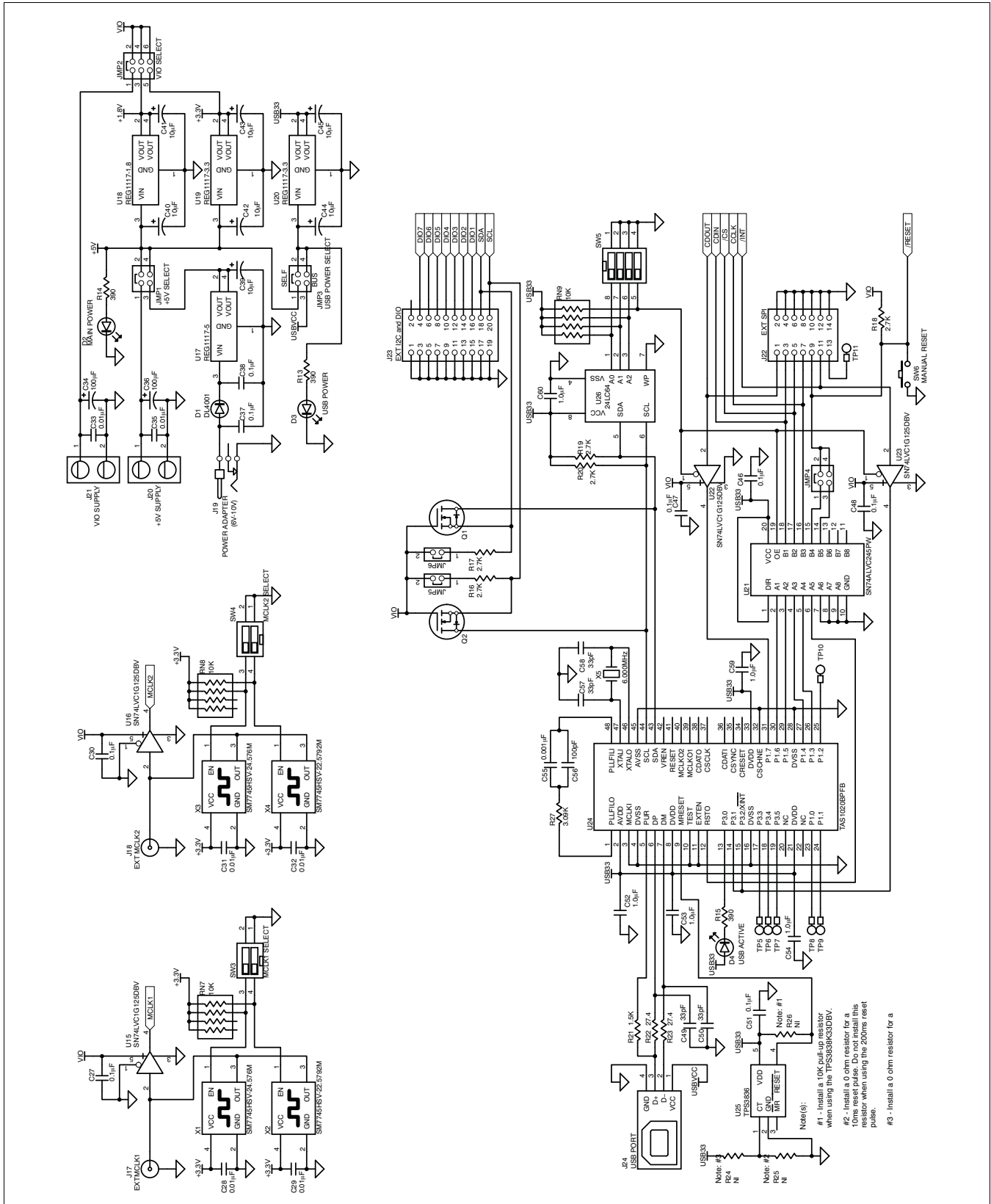


Figure 8. Electrical Schematic: DAIMB Motherboard, Page 2

4.2 Bills of Material

Table 14. Bill of Materials for the DIX4192EVM

ITEM	VALUE	REFERENCE DESIGNATOR	QTY PER BOARD	MFR	MFR PART NUMBER	DESCRIPTION
1	0	R3, R5	2	Panasonic	ERJ-3GEY0R00V	Resistor, 0Ω, Size = 0603
2	10	R1	1	Panasonic	ERJ-3GEYJ100V	Resistor, Thick Film Chip 10Ω, 5%, 1/10W, Size = 0603
3	2.7K	R4, R6	2	Panasonic	ERJ-3GEYJ272V	Resistor, Thick Film Chip, 2.7kΩ, 5%, 1/10W Size = 0603
4	100	RN1, RN2	2	CTS	742C083101J	Thick Film Chip Resistor Array 100Ω, 8-Terminal, 4 Resistors, Isolated
5	10k	RN3	1	CTS	742C163103J	Thick Film Chip Resistor Array 10kΩ, 16-Terminal, 8 Resistors, Isolated
6	0.1μF	C1, C3, C5, C7	4	TDK	C1608X7R1E104K	Chip Capacitor, X7R Ceramic 0.1μF ±10%, 25V, Size = 0603
7	10μF	C2, C4, C6, C8	4	Kemet	T491A106K010AS	Chip Capacitor, Tantalum, 10μF ±10%, 10V, Size = A
8		U1	1	Texas Instruments	DIX4192IPFB	Integrated Digital Audio Interface Receiver and Transmitter (DIR & DIT)
9		LED1	1	Lumex	SML-LX0603GW-TR	Green LED, SMT, Size = 0603
10		JA, JB, JC, JD	4	Samtec	SSW-110-02-G-D	Socket Strip, Dual Row, 10x2
11		JE	1	Samtec	SSW-105-02-G-D	Socket Strip, Dual Row, 5x2
12		JF	1	Samtec	SSW-115-02-G-D	Socket Strip, Dual Row, 15x2
13		JMP1	1	Samtec	TSW-104-07-G-D	Terminal Strip, Dual Row, 4x2
14		JMP2-JMP4	3	Samtec	TSW-102-07-G-D	Terminal Strip, Dual Row, 2x2
15		JMP5-JMP8	4	—	—	Bus Wire, 18 to 22 guage
16		SW1	1	ITT Industries/C&K	TDA04H0SK1	DIP Switch, 4-element, Half-pitch Surface-Mount, Tape Sealed
17			6	Samtec	SNT-100-BK-G-H	Shorting Blocks
18		PWB	1	Texas Instruments	6479511	DIX4192EVM Printed Circuit Board

Table 15. Bill of Materials for the DAIMB

ITEM	VALUE	REFERENCE DESIGNATOR	QTY PER BOARD	MFR	MFR PART NUMBER	DESCRIPTION
1	0	R3, R4, R24	3	Panasonic	ERJ-3GEY0R00V	Resistor, 0Ω, Size = 0603
2	Not Installed	R25	1	Panasonic	ERJ-3GEY0R00V	Resistor, 0Ω, Size = 0603
3	27.4	R22, R23	2	Panasonic	ERJ-3EKF27R4V	Resistor, Thick Film Chip 27.4Ω, 1%, 1/16W, Size = 0603
4	75	R1, R2, R6–R8	5	Panasonic	ERJ-3EKF75R0V	Resistor, Thick Film Chip 75Ω, 1%, 1/16W, Size = 0603
5	110	R5, R9	2	Panasonic	ERJ-3EKF1100V	Resistor, Thick Film Chip 110Ω, 1%, 1/16W, Size = 0603
6	150	R10–R12, R28–R30	6	Panasonic	ERJ-3EKF1500V	Resistor, Thick Film Chip 150Ω, 1%, 1/16W, Size = 0603
7	392	R13–R15	3	Panasonic	ERJ-3EKF3920V	Resistor, Thick Film Chip 392Ω, 1%, 1/16W, Size = 0603
8	1.5K	R21	1	Panasonic	ERJ-3EKF1501V	Resistor, Thick Film Chip 1.5kΩ, 1%, 1/16W, Size = 0603
9	2.7K	R16–R20	5	Panasonic	ERJ-3GEYJ272V	Resistor, Thick Film Chip 2.7kΩ, 5%, 1/10W Size = 0603
10	3.09K	R27	1	Panasonic	ERJ-3EKF3091V	Resistor, Thick Film Chip 3.09kΩ, 1%, 1/16W, Size = 0603
11	Not Installed	R26	1	Panasonic	ERJ-3EKF1002V	Resistor, Thick Film Chip 10kΩ, 1%, 1/16W, Size = 0603
12	100	RN1, RN3, RN4, RN6	4	CTS	742C083101J	Thick Film Chip Resistor Array 100Ω, 8-Terminal, 4 Resistors, Isolated
13	10k	RN2, RN5, RN7–RN9	5	CTS	742C083103J	Thick Film Chip Resistor Array 10kΩ, 8-Terminal, 4 Resistors, Isolated
14	33pF	C49, C50, C57, C58	4	TDK	C1608C0G1H330J	Chip Capacitor, C0G Ceramic 33pF ±5%, 50V, Size = 0603
15	100pF	C56	1	TDK	C1608C0G1H101J	Chip Capacitor, C0G Ceramic 100pF ±5%, 50V, Size = 0603
16	0.001μF	C55	1	TDK	C1608C0G1H102J	Chip Capacitor, C0G Ceramic 0.001μF ±5%, 50V, Size = 0603
17	0.01μF	C28, C29, C31–C33, C35	6	TDK	C1608X7R1H103K	Chip Capacitor, X7R Ceramic 0.01μF ±10%, 50V, Size = 0603
18	0.1μF	C1–C27, C30, C37, C46–C48, C51	33	TDK	C1608X7R1E104K	Chip Capacitor, X7R Ceramic 0.1μF ±10%, 25V, Size = 0603
19	1μF	C38, C52–C54, C59, C60	6	TDK	C1608X7R1C105K	Chip Capacitor, X7R Ceramic 1μF ±10%, 16V, Size = 0603
20	10μF	C39–C45	7	Kemet	T491A106K010AS	Chip Capacitor, Tantalum, 10μF ±10%, 10V, Size = A
21	100μF	C34, C36	2	Panasonic	EEV-FK1C101P	Capacitor, Alum Elect, SMT, 100μF ±20%, 16V, Size = D
22	47μH	L1	1	Panasonic	ELJ-FA470KF	Inductor, SMT, 47μH ±10%, Size = 1210
23		T1, T2	2	Scientific Conversion	SC939-06	Dual Zo Digital Audio Transformer
24		U1, U3, U5, U7	4	Texas Instruments	SN74ALVC244PWR	Octal Buffer/Driver with Tri-State Outputs
25		U2, U4, U6, U8, U21	5	Texas Instruments	SN74ALVC245PWR	Octal Bus Transceiver with Tri-State Outputs
26		U9	1	Toshiba	TORX179P	TOSLINK™ Optical Receiver
					or	
					TORX179PL	TOSLINK Optical Receiver
27		U10, U11, U14–U16, U22, U23	7	Texas Instruments	SN74LVC1G125DBVR	Single Buffer with Tri-State Output
28		U12	1	Texas Instruments	SN74AHCT1G125DBVR	Single Buffer with Tri-State Output and TTL Compatible Input
29		U13	1	Toshiba	TOTX179P	TOSLINK Optical Transmitter
					or	
					TOTX179PL	TOSLINK Optical Transmitter

Table 15. Bill of Materials for the DAIMB (continued)

ITEM	VALUE	REFERENCE DESIGNATOR	QTY PER BOARD	MFR	MFR PART NUMBER	DESCRIPTION
30		U17	1	Texas Instruments	REG1117-5	Linear Voltage Regulator with +5V Fixed Output
31		U18	1	Texas Instruments	REG1117A-1.8	Linear Voltage Regulator with +1.8V Fixed Output
32		U19, U20	2	Texas Instruments	REG1117-3.3	Linear Voltage Regulator with +3.3V Fixed Output
33		U24	1	Texas Instruments	TAS1020BPFB	USB Streaming Controller
34		U25	1	Texas Instruments	TPS3836K33DBVR	Nanopower Supervisory Circuit with Active Low Push-Pull Output
				or		
				Texas Instruments	TPS3838K33DBVR	Nanopower Supervisory Circuit with Active Low Open Drain Output (requires installation of R26)
35		U26		Microchip	24LC64I/SN	64k EEPROM with 2-wire I ² C Serial Interface
36		D1		Micro Commercial Components	DL4001	Diode, 50V, 1A, MELF SMT
37		D2, D3	2	Lumex	SML-LX0603GW-TR	Green LED, SMT, Size = 0603
38		D4	1	Lumex	SML-LX0603YW-TR	Yellow LED, SMT, Size = 0603
39		Q1, Q2	2	Zetex	ZXMN6A07F	N-channel MOSFET, SMT
40		X1, X3	2	Pletronics	SM7745HSV-24.576M	+3.3V SMT Clock Oscillator with CMOS Output and Active High Enable 24.576MHz ±50ppm
41		X2, X4	2	Pletronics	SM7745HSV-22.5792M	+3.3V SMT Clock Oscillator with CMOS Output and Active High Enable 22.5792MHz ±50ppm
42		X5	1	Citizen	HCM49-6.000MABJT	6.000MHz Crystal, SMT
				or		
				Epson	MA-505 6.000M-C0	6.000MHz Crystal, SMT
				or		
				CTS	ATS060SM-T	6.000MHz Crystal, SMT
43		J1–J4, JE	5	Samtec	TSW-105-07-G-D	Terminal Strip, Dual Row, 5x2
44		J5	1	Neutrik	NC3FAH2	3-pin Female XLR Chassis Connector, Horizontal PC Mount with Latch
45		J6–J9, J11, J13–J15	8	CUI Stack	RCJ-041	RCA Jack, PC Mount, Black
46		J10, J16, JMP5, JMP6	4	Samtec	TSW-102-07-G-S	Terminal Strip, 2x1
47		J12	1	Neutrik	NC3MAH-0	3-pin Male XLR Chassis Connector, Horizontal PC Mount
48		J17, J18	2	Tyco AMP	414305-1	BNC Connector, Female, PC Mount
49		J19	1	CUI Stack	PJ-102BH	2.5mm Male Power Jack, PCB Mount, Silver Plated
50		J20, J21	2	Weidmuller	1699670000	Terminal Block, 2 poles, 3.5mm PCB
51		J22	1	Samtec	TSW-107-07-G-D	Terminal Strip, Dual Row, 7x2
52		J23, JA, JB, JC, JD	5	Samtec	TSW-110-07-G-D	Terminal Strip, Dual Row, 10x2
53		J24	1	Mill-Max	897-30-004-90-000000	USB Type B Receptacle, Single, Through-Hole
54		JF	1	Samtec	TSW-115-07-G-D	Terminal Strip, Dual Row, 15x2
55		JMP1, JMP3	2	Samtec	TSW-102-07-G-D	Terminal Strip, Dual Row, 2x2
56	Not Installed	JMP4	1	Samtec	TSW-102-07-G-D	Terminal Strip, Dual Row, 2x2
57		JMP2	1	Samtec	TSW-103-07-G-D	Terminal Strip, Dual Row, 3x2
58		SW1-SW4	4	ITT Industries/C&K	TDA02H0SK1	DIP Switch, 2-element, Half-pitch Surface-Mount, Tape Sealed

Table 15. Bill of Materials for the DAIMB (continued)

ITEM	VALUE	REFERENCE DESIGNATOR	QTY PER BOARD	MFR	MFR PART NUMBER	DESCRIPTION
59		SW5	1	ITT Industries/C&K	TDA04H0SK1	DIP Switch, 4-element, Half-pitch Surface-Mount, Tape Sealed
60		SW6	1	Omron	B3S-1000	Momentary Tact Switch, SMT, Without Ground Terminal
61			5	Samtec	SNT-100-BK-G-H	Shorting Blocks
62			5	3M Bumpon	SJ-5003	Rubber Feet, Adhesive Backed
63		PWB	1	Texas Instruments	6472591	DAIMB Printed Circuit Board

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